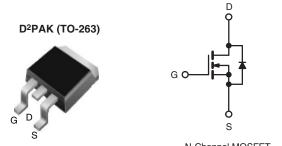


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Power MOSFET

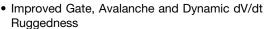
PRODUCT SUMMARY				
V _{DS} (V)	600			
$R_{DS(on)}\left(\Omega\right)$	V _{GS} = 10 V 1.2			
Q _g (Max.) (nC)	42			
Q _{gs} (nC)	10			
Q _{gd} (nC)	20			
Configuration	Single			



N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21 **Definition**
- \bullet Low Gate Charge Q_g results in Simple Drive Requirement





- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective Coss Specified
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching

TYPICAL SMPS TOPOLOGIES

Single Transistor Forward

ORDERING INFORMATION					
Package	D ² PAK (TO-263)	D ² PAK (TO-263)	D ² PAK (TO-263)		
Lead (Pb)-free and Halogen-free	SiHFBC40AS-GE3	SiHFBC40ASTRL-GE3a	SiHFBC40ASTRR-GE3a		
Load (Dh) fron	IRFBC40ASPbF	IRFBC40ASTRLPbFa	IRFBC40ASTRRPbFa		
Lead (Pb)-free	SiHFBC40AS-E3	SiHFBC40ASTL-E3 ^a	SiHFBC40ASTR-E3 ^a		

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage			V _{DS}	600		
Gate-Source Voltage			V_{GS}	± 30	V	
$T_{\rm C} = 25 ^{\circ}{\rm C}$			I-	6.2		
Continuous Drain Currente $V_{GS} \text{ at 10 V} \qquad \frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$		T _C = 100 °C	l _D	3.9	Α	
Pulsed Drain Current ^{a, e}			I _{DM}	25		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	570	mJ	
Repetitive Avalanche Current ^a			I _{AR}	6.2	Α	
Repetitive Avalanche Energy ^a			E_{AR}	13	mJ	
Maximum Power Dissipation $T_C = 25 ^{\circ}C$			P_{D}	125	W	
Peak Diode Recovery dV/dt ^{c, e}			dV/dt	6.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) for 10 s				300 ^d	7	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Starting T_J = 25 °C, L = 29.6 mH, R_g = 25 Ω , I_{AS} = 6.2 A (see fig. 12).
- c. $I_{SD} \le 6.2$ A, $dI/dt \le 88$ A/ μ s, $V_{DD} \le V_{DS}^{\sigma}$, $T_{J} \le 150$ °C.
- d. 1.6 mm from case.
- e. Uses IRFBC40A, SiHFBC40A data and test conditions.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFBC40AS, SiHFBC40AS

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THERMAL RESISTANCE RATINGS					
PARAMETER SYMBOL TYP. MAX. UNIT					
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.0		

SPECIFICATIONS (T _J = 25 °C, u		vise noted)			ı	ı	
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V_{DS}	V _{GS}	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, $I_D = 1 \text{ mA}^d$	ı	0.66	-	V/°C
Gate-Source Threshold Voltage	$V_{GS(th)}$	V _{DS} =	V_{GS} , $I_D = 250 \mu A$	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	1	-	± 100	nA
Zero Gate Voltage Drain Current	1	V _{DS} =	= 600 V, V _{GS} = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 3.7 A ^b	-	-	1.2	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 3.7 A	3.4	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	1036	-	
Output Capacitance	C _{oss}		$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		136	-	1
Reverse Transfer Capacitance	C _{rss}] f = 1	.0 MHz, see fig. 5	-	7.0	-	pF
Output Capacitance	C _{oss}	V _{GS} = 0 V	V _{DS} = 1.0 V, f = 1.0 MHz	-	1487	-	
			V _{DS} = 480 V, f = 1.0 MHz	-	36	-	
Output Capacitance Effective	C _{oss} eff.	V _{DS} = 0 V to 480 V ^c		-	48	-	
Total Gate Charge	Qg		V _{GS} = 10 V I _D = 6.2 A, V _{DS} = 480 V, see fig. 6 and 13 ^b		-	42	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V			-	10	nC
Gate-Drain Charge	Q _{gd}]	ooo ng. o ana ro	-	-	20	1
Turn-On Delay Time	t _{d(on)}			-	13	-	
Rise Time	t _r		300 V, I _D = 6.2 A,	-	23	-	
Turn-Off Delay Time	t _{d(off)}	$\frac{1}{1}$ $\frac{R_g}{1}$	$R_g = 9.1 \Omega, R_D = 47 \Omega,$ see fig. 10 ^b		31	-	ns
Fall Time	t _f	1		-	18	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6.2	^
Pulsed Diode Forward Current ^a	I _{SM}			-	-	25	A
Body Diode Voltage	V _{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 6.2 \text{A}, V_{GS} = 0 \text{V}^{\text{b}}$		-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 6.2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^b$		-	431	647	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	1.8	2.8	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)				L _D)	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.
- c. C_{OSS} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising fom 0 to 80 % V_{DS} .
- d. Uses IRHFBC40A/SiHFBC40A data and test conditions.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

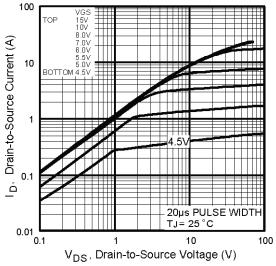


Fig. 1 - Typical Output Characteristics

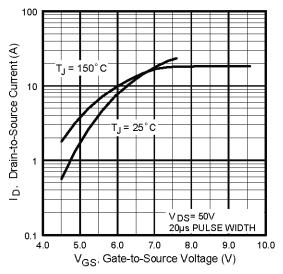


Fig. 3 - Typical Transfer Characteristics

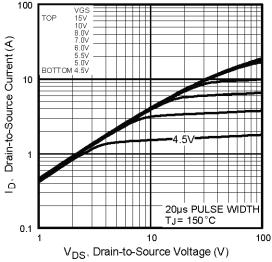


Fig. 2 - Typical Output Characteristics

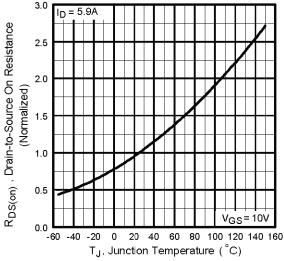


Fig. 4 - Normalized On-Resistance vs. Temperature

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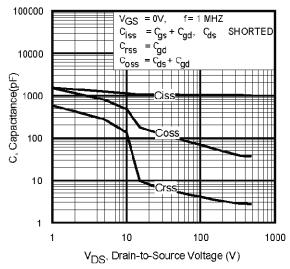


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

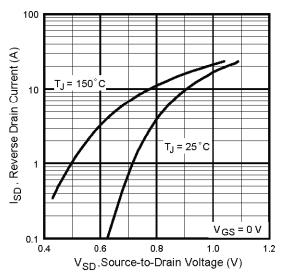


Fig. 7 - Typical Source-Drain Diode Forward Voltage

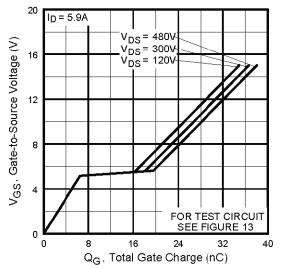


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

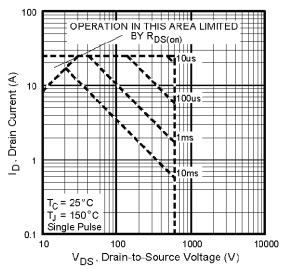


Fig. 8 - Maximum Safe Operating Area



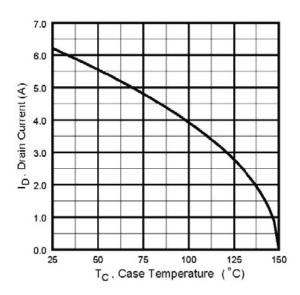


Fig. 9 - Maximum Drain Current vs. Case Temperature

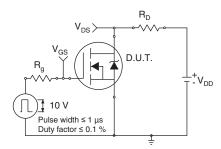


Fig. 10a - Switching Time Test Circuit

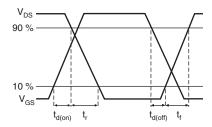


Fig. 10b - Switching Time Waveforms

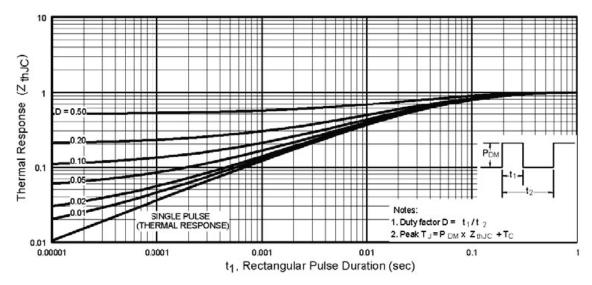


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

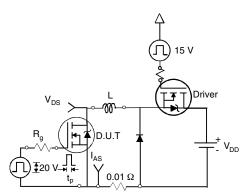


Fig. 12a - Unclamped Inductive Test Circuit

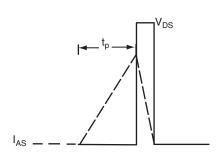


Fig. 12b - Unclamped Inductive Waveforms

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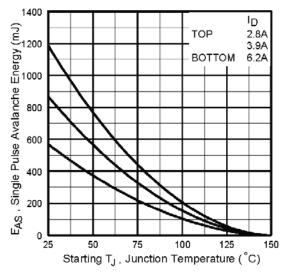


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

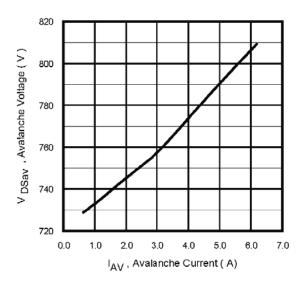


Fig. 12d - Maximum Avalanche Energy vs. Drain Current

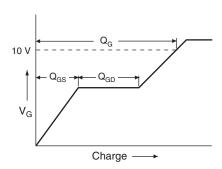


Fig. 13a - Basic Gate Charge Waveform

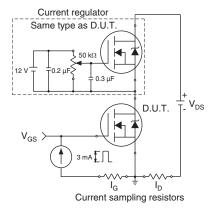
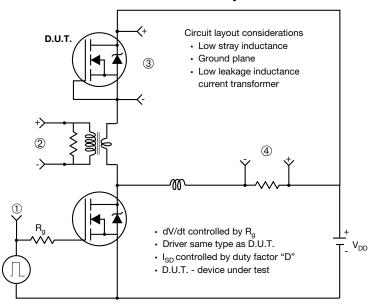


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



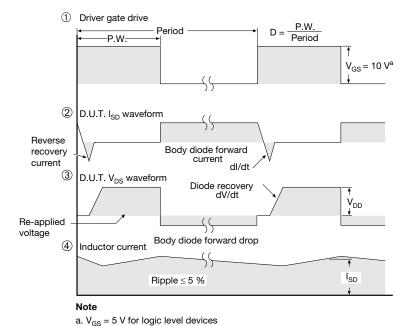


Fig. 14 - For N-Channel

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TO-263AB (HIGH VOLTAGE)







	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	ı
е	2.54 BSC		0.100 BSC	
Н	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	ı	0.066
L2	-	1.78	-	0.070
L3	0.25 BSC		0.010	BSC
L4	4.78	5.28	0.188	0.208

ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

Document Number: 91364 www.vishay.com Revision: 15-Sep-08





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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